Low Power Single Voltage Comparator

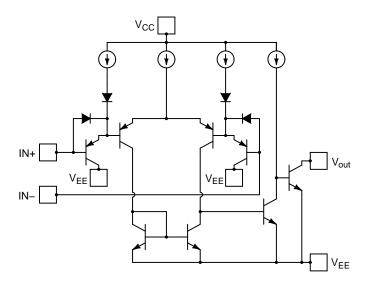
Description

The TS391 is an open collector, low–power voltage comparator designed specifically to operate from a single supply over a wide range of voltages. Operation from split power supplies is also possible.

This comparator also has a unique characteristic in that the input common-mode voltage range includes ground, even though operated from a single power supply voltage.

Features

- Wide Single Supply Voltage Range or Dual Supplies
- Low Supply Current (0.5 mA) Independent of Supply Voltage (1 mW/Comparator at +5 V)
- Low Input Bias Current: 25 nA TYP
- Low Input Offset Current: ±5 nA TYP
- Low Input Offset Voltage: ±1 mV TYP
- Input Common Mode Voltage Range includes Ground
- Low Output Saturation Voltage: 250 mV TYP at I_O = 4 mA
- Differential Input Voltage Range Equal to the Supply Voltage
- TTL, DTL, ECL, CMOS Compatible Devices
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable





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MARKING DIAGRAM



Analog

391 = Specific Device CodeA = Assembly Location

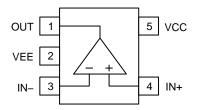
′ = Year

W = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

PIN CONNECTIONS



ORDERING INFORMATION

Device	Package	Shipping [†]
TS391SN2T1G	TSOP-5 (Pb-Free)	3000 / Tape & Reel
NCV391SN2T1G*	TSOP-5 (Pb-Free)	3000 / Tape & Reel

- †For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.
- * NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable

Table 1. ABSOLUTE MAXIMUM RATINGS (Over operating free-air temperature, unless otherwise stated)

Parameter	Symbol	Limit	Unit
Supply Voltage (V _{CC} – V _{EE})	V _S	36	V
INPUT AND OUTPUT PINS			
Input Voltage	V _{IN}	-0.3 to 36	V
Differential Input Voltage	V _{ID}	±36	V
Output Short Circuit Current (Note 1)	I _{SC}	20	mA
TEMPERATURE			
Storage Temperature	T _{STG}	-65 to +150	°C
Junction Temperature	TJ	+150	°C
ESD RATINGS			
Human Body Model	НВМ	1500	V
Charged Device Model	CDM	2000	V
Machine Model	MM	200	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Short circuits from the output to V_{CC} can cause excessive heating and potential destruction. The maximum short circuit current is independent

Table 2. THERMAL INFORMATION (Note 2)

Thermal Metric	Symbol	Limit	Unit
Junction to Ambient – SOIC8	θ_{JA}	238	°C/W

^{2.} Short-circuits can cause excessive heating and destructive dissipation. These values are typical.

Table 3. OPERATING CONDITIONS

Parameter	Symbol	Limit	Unit
Operating Supply Voltage	V _S	2 to 36	V
Specified Operating Range	T _A	-40 to +125	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

of the magnitude of V_{CC} .

Table 4. ELECTRICAL CHARACTERISTICS (Vs=+5.0 V, At T_A = +25°C) Boldface limits apply over the specified temperature range, T_A = -40°C to +125°C.

Parameter	Symbol	Test	Conditions	Min	Тур	Max	Unit
INPUT CHARACTERISTIC	s						
Offset Voltage	Vos	Vo = 1.4 V, R _S =	$V_{CM} = 0 \text{ to } V_{CC} - 1.5 \text{ V}$		1	5	mV
		$0 \Omega, V_S = 5 V \text{ to}$ 30 V	$V_{CM} = 0$ to $V_{CC} - 2$ V			9	mV
Input Bias Current	I _{IB}				25	250	nA
						400	nA
Input Offset Current	I _{OS}				5	50	nA
						150	nA
Input Common Mode	V _{ICR}			0		V _{CC} – 1.5	V
Range (Note 3)				0		V _{CC} – 2	٧
Differential Input Voltage (Note 4)	V _{ID}					V _{CC}	V
OUTPUT CHARACTERIST	TICS						
Output Voltage Low	out Voltage Low V_{OL} $V_{ID} = 1 \text{ V, } I_{O} = 4 \text{ mA}$		I V, I _O = 4 mA		250	400	mV
						700	mV
Output Sink Current	I _O	$V_{ID} = -1, V_{O} = 1.5 V$		6	16		mA
Output Leakage Current	I _{OH}	V _{ID} = 1 V, V _{CC} = V _O = 5 V			0.1		nA
		$V_{ID} = 1 V$,	$V_{ID} = 1 \text{ V}, V_{CC} = V_{O} = 30 \text{ V}$			1	μΑ
DYNAMIC PERFORMANC	E						
Open Loop Voltage Gain	A _{VOL}	V _{CC} = 15	V , R_{PU} = 15 $kΩ$	94	106		dB
Propagation Delay L-H	y L–H t _{PLH}	5 mV overd	rive, $R_{PU} = 5.1 \text{ k}\Omega$		850		ns
		20 mV overdrive, R_{PU} = 5.1 kΩ			490		ns
		100 mV overdrive, R_{PU} = 5.1 k Ω			300		ns
		TTL Inpu R _{PI}	it, Vref = +1.4 V, $_{\rm J}$ = 5.1 k Ω		220		ns
Propagation Delay H-L	t _{PHL}	5 mV overdrive, R_{PU} = 5.1 k Ω			620		ns
		20 mV overdrive, R _{PU} = 5.1 kΩ			400		ns
		100 mV over	drive, $R_{PU} = 5.1 \text{ k}\Omega$		250		ns
			t, Vref = +1.4 V, _U = 5.1 kΩ		350		ns
POWER SUPPLY							
Quiescent Current	I _{CC}	V	_{CC} = 5 V		0.5	-	mA
		Vo	_{CC} = 30 V		0.5	1.25	mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{3.} The input common mode voltage of either input signal should not be allowed to go negative by more than 0.3 V. The upper end of the common mode voltage range is VCC – 1.5 V, but either or both inputs can go to +30 V without damage.

^{4.} Positive excursions of the input voltage may exceed the power supply level. As long as the other voltage remains within the common mode range, the comparator will provide a proper output stage. The low input voltage state must not be less than 0.3 V below the negative supply rail.

TYPICAL CHARACTERISTICS

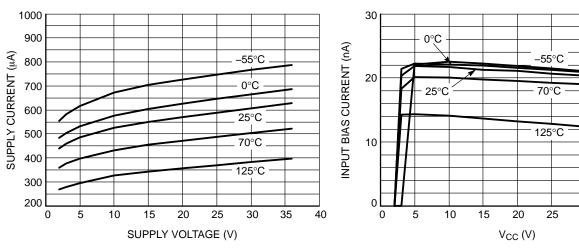


Figure 1. Supply Current vs. Supply Voltage



 $V_{IN} = 0 V$

35

40

30

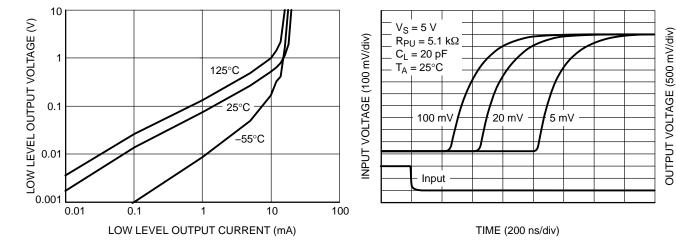


Figure 3. Low Level Output Voltage vs. Output
Current

Figure 4. Propagation Delay L-H vs. Overdrive

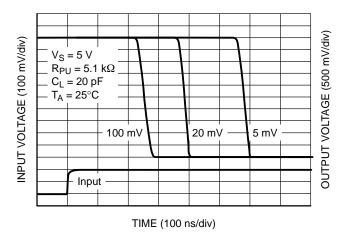
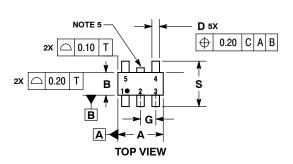


Figure 5. Propagation Delay H-L vs. Overdrive

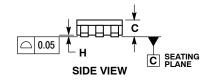


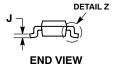
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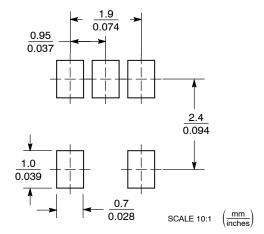


NOTES:

- DIMENSIONING AND TOLERANCING PER ASME
- CONTROLLING DIMENSION: MILLIMETERS.
 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH
 THICKNESS. MINIMUM LEAD THICKNESS IS THE
 MINIMUM THICKNESS OF BASE MATERIAL.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE. DIMENSION A. OPTIONAL CONSTRUCTION: AN ADDITIONAL
- TRIMMED LEAD IS ALLOWED IN THIS LOCATION. TRIMMED LEAD NOT TO EXTEND MORE THAN 0.2 FROM BODY.

	MILLIMETERS			
DIM	MIN	MAX		
Α	2.85	3.15		
В	1.35	1.65		
C	0.90	1.10		
D	0.25	0.50		
G	0.95 BSC			
Н	0.01	0.10		
J	0.10	0.26		
K	0.20	0.60		
М	0 °	10 °		
S	2 50	3.00		

SOLDERING FOOTPRINT*



^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*





XXX = Specific Device Code XXX = Specific Device Code

= Assembly Location = Date Code

= Year = Pb-Free Package

= Work Week W

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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